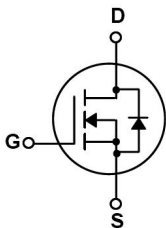


/ Descriptions

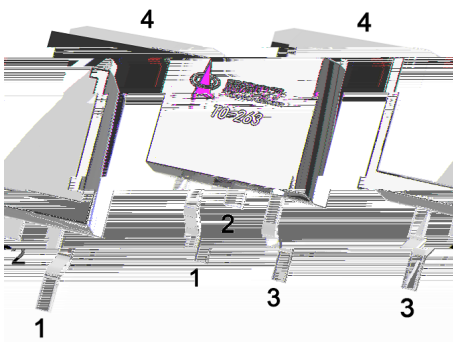
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking

/ Absolute Maximum Ratings(Ta=25)

		℃		
		℃		
	≤	θ		
		θ		

/ Electrical Characteristics(Ta=25)

		μ				
						μ
		μ				
						Ω

/ Electrical Characteristics(Ta=25)

						Ω
		Ω Ω				

/ Electrical Characteristic Curve

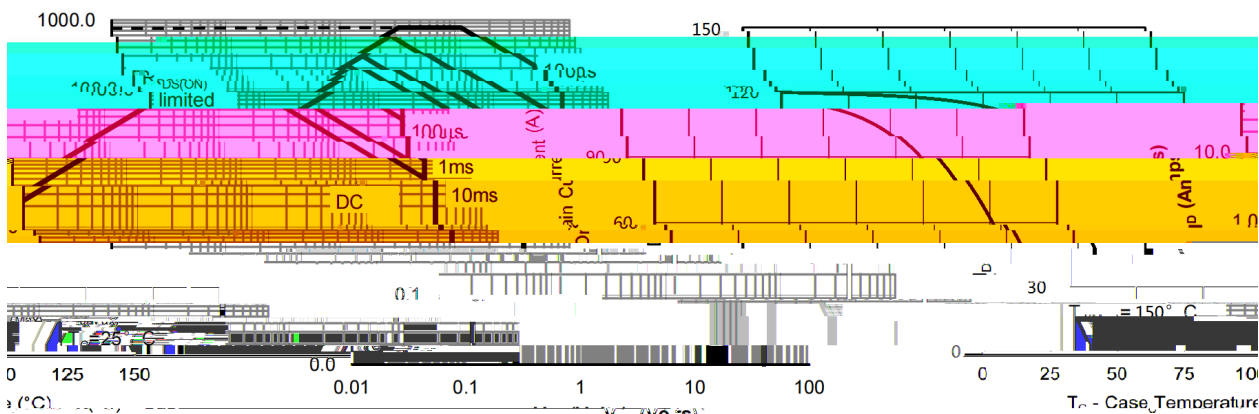
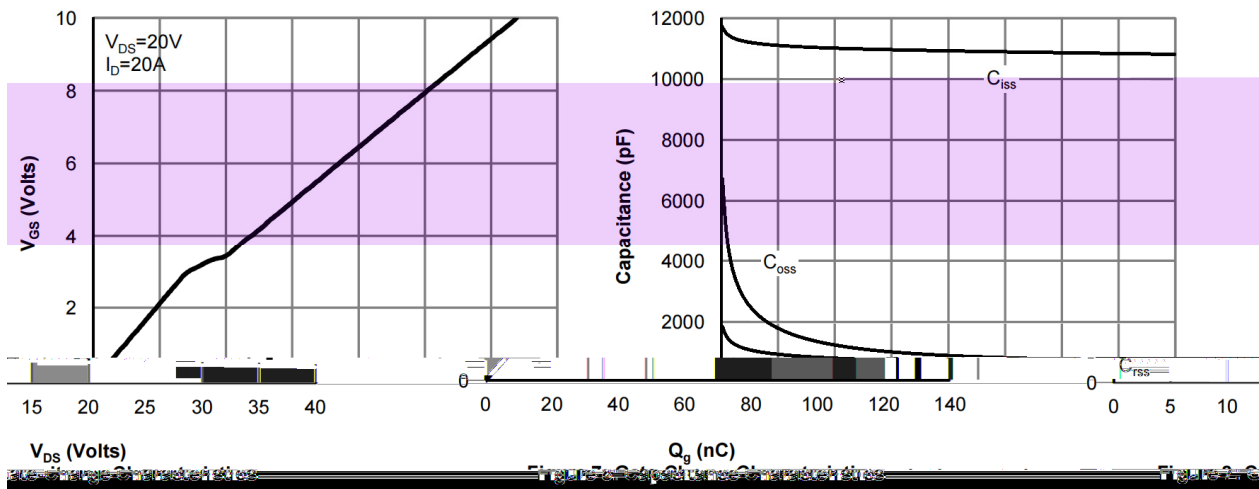


Figure 9: Maximum Forward Biased Safe Operating Area

Figure 10: Maximum C_{oss} vs Case Temperature

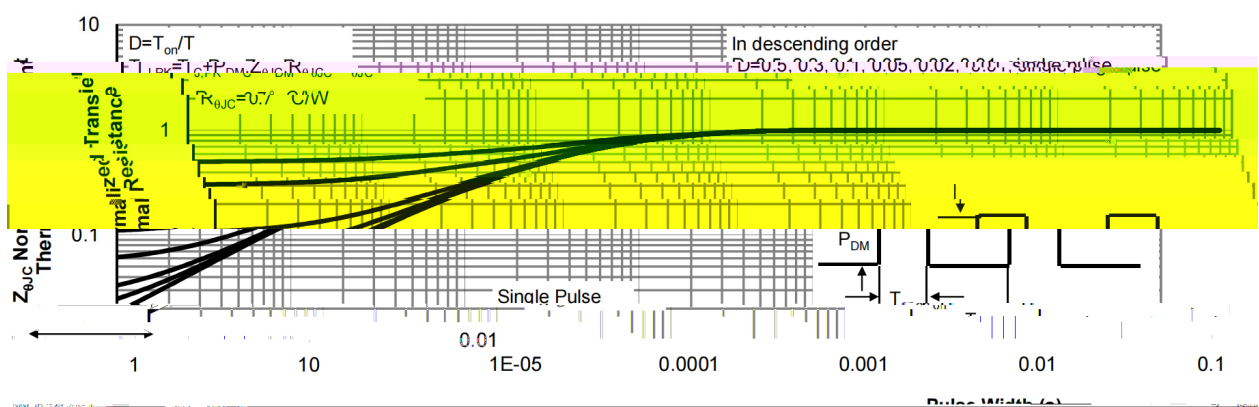
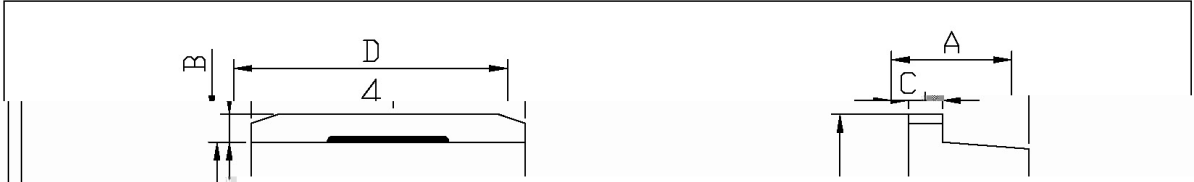


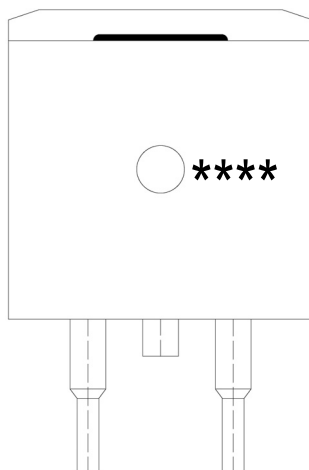
Figure 11: Normalized Maximum Transient Thermal Impedance

/ Package Dimensions

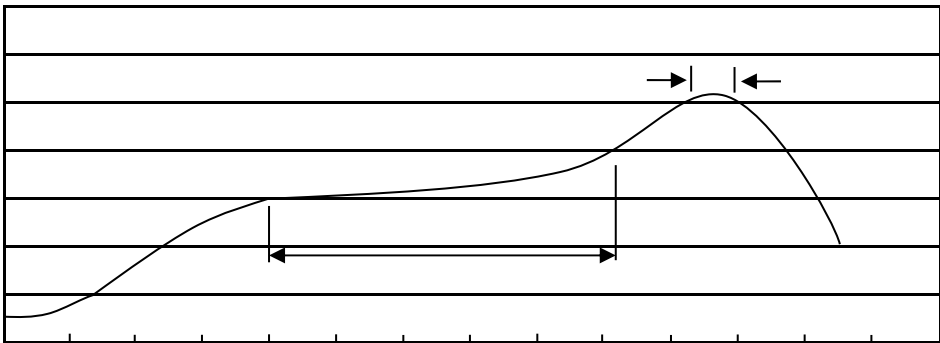


		单位: mm					
Symbol	Dimensions in Millimeters		Symbol	Dimensions in Millimeters			
	Min	Max		Min	Max		
A	4.30	4.70	E	9.00	9.50		
B	1.00	1.40	e1	2.34	2.54		
b	0.70	0.90	e2	4.88	5.08		
b1	1.15	1.35	L1	15.00			
b2	0.40	0.60	L2	2.24			
C	1.20	1.40	L3	1.20			
D	9.80	10.20					
T0-263							

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
						"		

	Units/Tube /	Tubes/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Tube	Inner Box	Outer Box

/ Notices